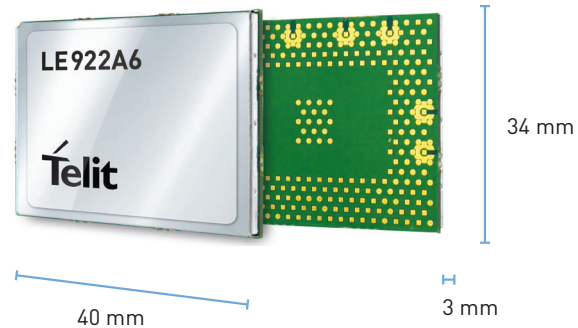


## LE922A6 Series

LTE 300/50 | HSPA+ 42.0/11.5 | Embedded



### Product Description

The LE922A6 product series deliver high speed data rates for deployment in the fastest LTE cellular 4G networks up to 300 Mbps downlink and 50Mbps in uplink.

These modules are therefore particularly well-suited, but not limited, to those devices that have extremely high data throughput requirements, such as mobile broadband gateways and routers, taking the benefit of the most advanced 3GPP Release 10 LTE connectivity in one of the following configurations:

- Back up connectivity when primary wire line internet connections are not available, ensuring seamless connectivity to the end users
- Hybrid connectivity combining DSL and LTE data stream to enhance data rate
- Mobile hotspots with MiFi connectivity

The LE922A6 products are optimized for LTE Cat 6 high throughput, supporting MIMO and LTE Advanced carrier aggregation capabilities.

In addition, for voice applications, specific models support integrated enhanced VoLTE based services and IMS solutions with SRVCC over 3G for seamless voice continuity during mobility.

### Key Benefits

- Take advantage of the latest generation of LTE-A networks delivering LTE Cat 6 throughput up to 300 Mbps in DL and 50 Mbps in UL

- Increased connectivity performance with carrier aggregation up to 40MHz bandwidth, both intraband and interband, and MIMO 2x2
- Multiple regional variants to support the various bands (FDD/TDD) and band combinations deployed world-wide, all with the same form factor
- LGA form factor well suits the industrial segments, where requirements for improved robustness as well as extended temperature range are more demanding, without compromising the efficiency for retail solutions
- Cortex-A7 application processor with high computing capability already embedded in the SoC to reduce dependencies from an external host processor for all those end-products as portable MiFi routes, that do not require additional Ethernet or analogic interfaces

### Variants

Two different models are available to fulfill the requirements of the Australian and European market and additional regional variants will follow.

Multi-band configurations, covering different sets of 4G bands and 3G bands where fall back to 3G technologies is required.

All product variants add the value of specific MNO certifications as well as regulatory certifications and GCF or PTCRB.

AVAILABLE FOR

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Complete,  
Ready to Use Access  
to the Internet of Things



	LE922A6-A1	LE922A6-E1
<b>Market</b>	Australia	Europe
<b>4G bands (MHz)</b>	B28(700) B3(1800) B1(2100) B7(2600) B40(2300)	B20(800) B3(1800) B7(2600)
<b>3G bands (MHz)</b>	900/2100	•
<b>Carrier Aggregation</b>	DL 2CA 1+7, 1+28, 3+3, 3+28, 3+40, 7+7, 28+7, 40+40	DL 2CA 3+20, 3+7, 7+20, 3+3, 7+7
<b>Technology</b>	Rel. 10 LTE FDD & TDD, Cat 6 2C-HSPA+	Rel.10 LTE FDD, Cat 6
<b>Data Throughput</b>	LTE FDD: DL: 300 Mbps, UL: 50 Mbps	DC-HSPA+: DL: 42 Mbps, UL: 11 Mbps
<b>RX Diversity</b>	YES	YES
<b>MIMO</b>	2x2 DL SU-MIMO 4x2 MIMO	2x2 DL SU-MIMO 4x2 MIMO
<b>VoLTE</b>	YES	YES
<b>Operating Temperature</b>	-40°C to +85°C	-40°C to +85°C
<b>Supply Voltage</b>	3.6 V to 4.2 V (Typ. 3.8 V)	3.6 V to 4.2 V (Typ. 3.8 V)
<b>GPIO</b>	10	10
<b>USB</b>	3.0	3.0
<b>UART</b>	YES	YES
<b>SPI</b>	YES	YES
<b>I2C</b>	YES	YES
<b>SDIO</b>	YES	YES
<b>Dimensions</b>	34 x 40 x 3mm	34 x 40 x 3mm
<b>Certifications</b>	RCM, GCF Carrier Approval	R&TTE, GCF Carrier Approval

## QUESTIONS? VISIT [WWW.TELIT.COM/CONTACT-US](http://WWW.TELIT.COM/CONTACT-US)

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